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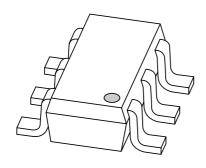
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DATA SHEET



PBSS4240DPN40 V low V_{CEsat} NPN/PNP transistor

Product data sheet 2003 Feb 20



40 V low V_{CEsat} NPN/PNP transistor

PBSS4240DPN

FEATURES

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain hFE at high IC
- · High efficiency leading to reduced heat generation
- Reduced printed-circuit board area requirements.

APPLICATIONS

- Power management:
 - Complementary MOSFET driver
 - Dual supply line switching.
- Peripheral driver:
 - Half and full bridge motor drivers
 - Multi-phase stepper motor driver.

DESCRIPTION

NPN/PNP low V_{CEsat} transistor pair in a SOT457 (SC-74) plastic package.

MARKING

TYPE NUMBER	MARKING CODE
PBSS4240DPN	M3

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MA	UNIT		
STIMBUL	PARAMETER	NPN	PNP	CIVIT	
V _{CEO}	emitter-collector voltage	40	-40	V	
I _C	collector current (DC)	1.35	-1.1	Α	
I _{CRP}	repetitive peak collector current	2	-2	Α	
I _{CM}	peak collector current	3	-3	Α	
R _{CEsat}	equivalent on-resistance	200	260	mΩ	

PINNING

PIN	DESCRIPTION		
1, 4	emitter	TR1; TR2	
2, 5	base	TR1; TR2	
6, 3	collector	TR1; TR2	

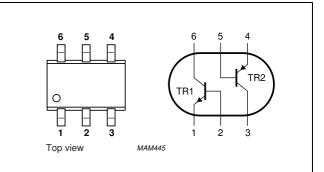


Fig.1 Simplified outline SOT457 (SC-74) and symbol.

40 V low V_{CEsat} NPN/PNP transistor

PBSS4240DPN

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transistor unless otherwise specified; for the PNP transistor with negative polarity					
V_{CBO}	collector-base voltage	open emitter	_	40	V
V_{CEO}	collector-emitter voltage	open base	_	40	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
I _C	collector current (DC)		_		
	NPN		_	1.35	Α
	PNP		_	-1.1	Α
I _{CRP}	repetitive peak collector current	note 1	_	2	Α
I _{CM}	peak collector current	single peak	_	3	Α
I _B	base current (DC)		_	300	mA
I _{BM}	peak base current		_	1	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 2	_	370	mW
		T _{amb} ≤ 25 °C; note 3	_	310	mW
		T _{amb} ≤ 25 °C; note 1	_	1.1	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C
Per device	;	•		•	·
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 2	_	600	mW

Notes

- 1. Operated under pulsed conditions: duty cycle $\delta \le 20\%$; pulse width tp ≤ 10 ms; mounting pad for collector standard footbrint.
- 2. Device mounted on a printed-circuit board; single-sided copper; tinplated; mounting pad for collector 1 cm².
- 3. Device mounted on a printed-circuit board; single-sided copper; tinplated; standard footprint.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per transi	stor			
R _{th j-a}	thermal resistance from junction to	in free air; note 1	340	K/W
	ambient	in free air; note 2	110	K/W

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- 2. Operated under pulsed conditions: pulse width $t_p \le 10$ ms; duty cycle $\delta \le 0.20$; mounting pad for collector standard footprint.

40 V low V_{CEsat} NPN/PNP transistor

PBSS4240DPN

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER CONDITIONS		MIN.	TYP.	MAX.	UNIT
Per transistor unless otherwise specified; for the PNP transistor with negative polarity						
I _{CBO}	collector-base cut-off current	$V_{CB} = 40 \text{ V}; I_{E} = 0$	_	_	100	nA
		$V_{CB} = 40 \text{ V}; I_E = 0; T_j = 150 ^{\circ}\text{C}$	Ī-	_	50	μΑ
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0	_	_	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	_	100	nA
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 1 mA	300	_	_	
f _T	transition frequency	I _C = 50 mA; V _{CE} = 10 V; f = 100 MHz	150	_	_	MHz
C _c	collector capacitance	V _{CB} = 10 V; I _E = I _e = 0; f = 1 MHz	_	_	12	pF
TR1 (NPN))	•	•	•	•	
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 500 \text{ mA}$	300	_	900	
		V _{CE} = 5 V; I _C = 1 A	200	_	_	
		V _{CE} = 5 V; I _C = 2 A; note 1	75	_	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 1 mA	_	60	75	mV
		$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	_	80	100	mV
		I _C = 1 A; I _B = 100 mA	_	150	200	mV
		$I_C = 2 A$; $I_B = 200 \text{ mA}$; note 1	_	300	400	mV
V_{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	_	_	1.2	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ A}$	_	_	1.1	V
R _{CEsat}	equivalent on-resistance	I _C = 1 A; I _B = 100 mA	_	_	200	mΩ
TR2 (PNP))					
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -100 \text{ mA}$	300	_	800	
		$V_{CE} = -5 \text{ V}; I_{C} = -500 \text{ mA}$	250	_	_	
		$V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ A}$	160	_	_	
		$V_{CE} = -5 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$	50	_	_	
V _{CEsat}	saturation voltage	$I_C = -100 \text{ mA}; I_B = -1 \text{ mA}$	_	-90	-120	mV
		$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	-100	-145	mV
		$I_C = -1 A$; $I_B = -100 \text{ mA}$	_	-180	-260	mV
		$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	-400	-530	mV
V_{BEsat}	saturation voltage	$I_C = -1 A$; $I_B = -50 \text{ mA}$	_	_	-1.1	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ A}$	_	_	-1	٧
R _{CEsat}	equivalent on-resistance	$I_C = -1 A$; $I_B = -100 \text{ mA}$; note 1	_	_	260	$m\Omega$

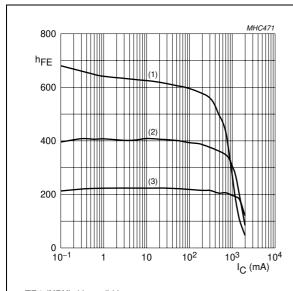
Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

2003 Feb 20

40 V low V_{CEsat} NPN/PNP transistor

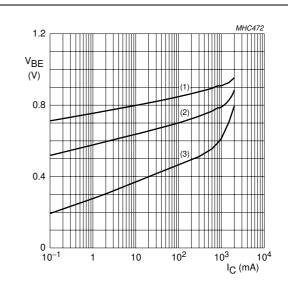
PBSS4240DPN



TR1 (NPN); $V_{CE} = 5 \text{ V}.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55$ °C.

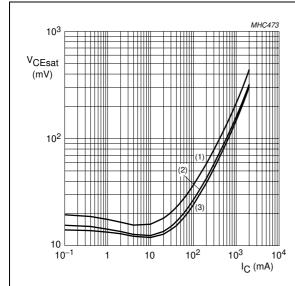
Fig.2 DC current gain as a function of collector current; typical values.



TR1 (NPN); $V_{CE} = 5 \text{ V}.$

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

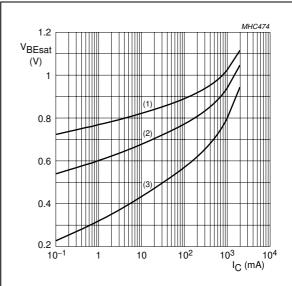
Fig.3 Base-emitter voltage as a function of collector current; typical values.



TR1 (NPN); $I_C/I_B = 20$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



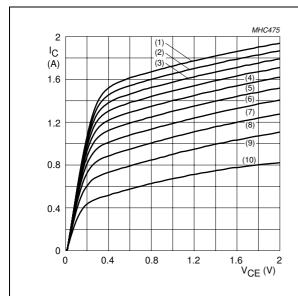
TR1 (NPN); $I_C/I_B = 20$.

- (1) $T_{amb} = -55 \,^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

40 V low V_{CEsat} NPN/PNP transistor

PBSS4240DPN

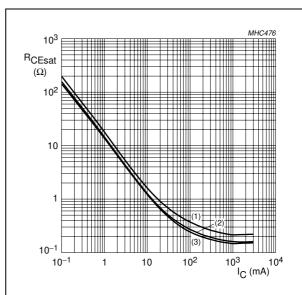


TR1 (NPN); $T_{amb} = 25 \, ^{\circ}C$.

- (1) $I_B = 30 \text{ mA}.$
- (5) $I_B = 18 \text{ mA}.$ (6) $I_B = 15 \text{ mA}.$
- (9) $I_B = 6 \text{ mA}.$ (10) $I_B = 3 \text{ mA}.$

- (2) $I_B = 27 \text{ mA}.$
- (7) $I_B = 12 \text{ mA}.$
- $\begin{array}{ll} (3) & I_B = 24 \ mA. \\ (4) & I_B = 21 \ mA. \\ \end{array}$
- (8) $I_B = 9 \text{ mA}.$

Fig.6 Collector current as a function of collector-emitter voltage; typical values.



TR1 (NPN); $I_C/I_B = 20$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

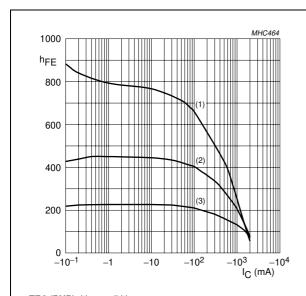
Fig.7 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

2003 Feb 20

6

40 V low V_{CEsat} NPN/PNP transistor

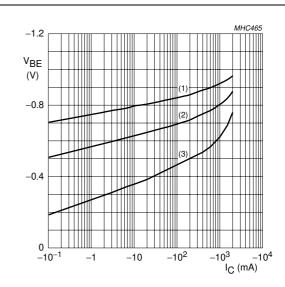
PBSS4240DPN



TR2 (PNP); $V_{CE} = -5 \text{ V}.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

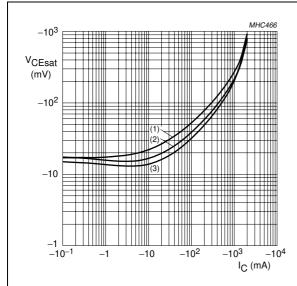
Fig.8 DC current gain as a function of collector current; typical values.



TR2 (PNP); $V_{CE} = -5 \text{ V}.$

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

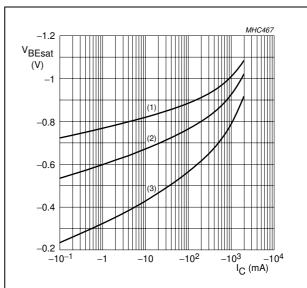
Fig.9 Base-emitter voltage as a function of collector current; typical values.



TR2 (PNP); $I_{C}/I_{B} = 20.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.10 Collector-emitter saturation voltage as a function of collector current; typical values.



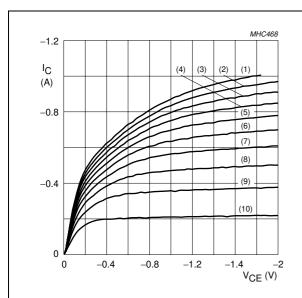
TR2 (PNP); $I_C/I_B = 20$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.11 Base-emitter saturation voltage as a function of collector current; typical values.

40 V low V_{CEsat} NPN/PNP transistor

PBSS4240DPN



TR2 (PNP); $T_{amb} = 25 \, ^{\circ}C$.

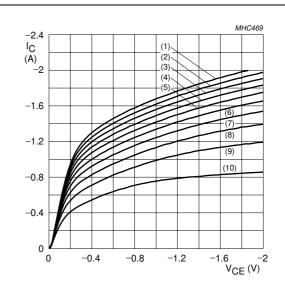
(1) $I_B = -7 \text{ mA}$. (2) $I_B = -6.3 \text{ mA}$. (5) $I_B = -4.2 \text{ mA}.$ (6) $I_B = -3.5 \text{ mA}.$ (9) $I_B = -1.4 \text{ mA}.$ (10) $I_B = -0.7 \text{ mA}.$

(3) $I_B = -5.6 \text{ mA}.$

(7) $I_B = -2.8 \text{ mA}.$

(4) $I_B = -4.9 \text{ mA}$. (8) $I_B = -2.1 \text{ mA}$.

Fig.12 Collector current as a function of collector-emitter voltage; typical values.



TR2 (PNP); $T_{amb} = 25 \, ^{\circ}C$.

(1) $I_B = -50 \text{ mA}.$

(5) $I_B = -30 \text{ mA}.$

(9) $I_B = -10 \text{ mA}.$ (10) $I_B = -5 \text{ mA}.$

(2) $I_B = -45 \text{ mA}.$ (3) $I_B = -40 \text{ mA}.$ (4) $I_B = -35 \text{ mA}.$

8

(6) $I_B = -25 \text{ mA}.$ (7) $I_B = -20 \text{ mA}.$

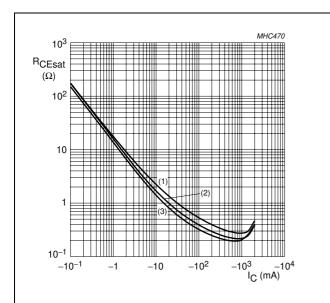
(8) $I_B = -15 \text{ mA}.$

Fig.13 Collector current as a function of collector-emitter voltage; typical values.

2003 Feb 20

40 V low V_{CEsat} NPN/PNP transistor

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TR2 (PNP); $I_{C}/I_{B} = 20$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.14 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

40 V low V_{CEsat} NPN/PNP transistor

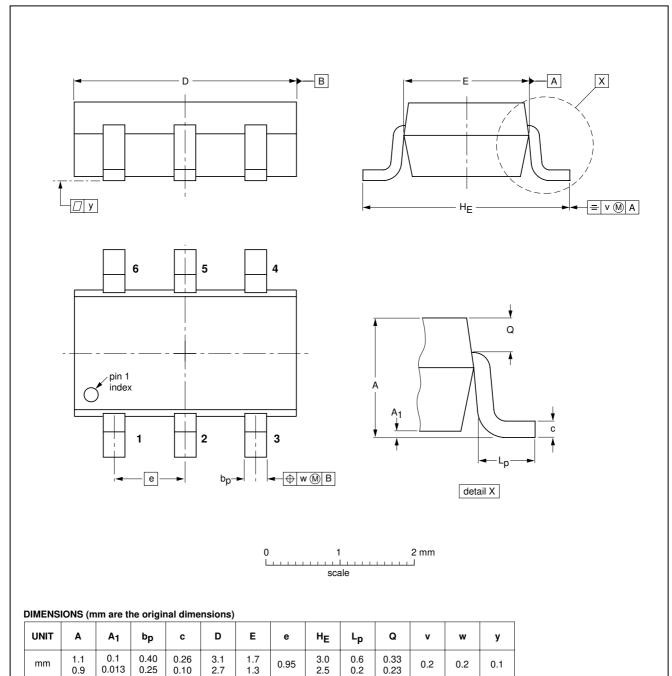
PBSS4240DPN

PACKAGE OUTLINE

mm

Plastic surface mounted package; 6 leads

SOT457



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT457			SC-74			97-02-28 01-05-04

0.2

0.2

0.1

0.95

2003 Feb 20 10

0.25

40 V low V_{CEsat} NPN/PNP transistor

PBSS4240DPN

DATA SHEET STATUS

DOCUMENT STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITION
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Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

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